

Supplier Name: Texas Instruments Inc. (DUNS# 00-732-1904)
Contact Info: [ti.com/support](https://www.ti.com/support)
Form/Declaration Type: Distribute - RoHS and IEC 62474 DB
Created on: 06/11/2022

Details for "TPS72727DSER"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
TPS72727DSER	NIPDAU	Level-1-260C-UNLIM	Ext-Mfg	DSE 6	1.5x1.5x0.75	4.1

***Total Device Mass**
The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

Component Information

				Homogeneous Material Level		Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Not Categorized	Proprietary Materials		0.000002	0.006707	67	0.000048	0
Precious Metals	Gold	7440-57-5	0.029816	99.993293	999933	0.721755	7218
Sub-Total			0.029818	100	1000000	0.721803	7218
Die Attach Adhesive							
Other Inorganic Materials	Aluminum Oxide	1344-28-1	0.021865	29.999726	299997	0.529285	5293
Other Inorganic Materials	Silica	7631-86-9	0.00328	4.500302	45003	0.079399	794
Other Organic Materials	Chlorine	7782-50-5	0.000026	0.035673	357	0.000629	6
Thermoplastics	Epoxy	85954-11-6	0.047713	65.464299	654643	1.154987	11550
Sub-Total			0.072884	100	1000000	1.7643	17643
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	1.462995	97.533	975330	35.414664	354147
Copper and Its Alloys	Iron	7439-89-6	0.034755	2.317	23170	0.841313	8413
Copper and Its Alloys	Phosphorus	7723-14-0	0.000375	0.025	250	0.009078	91
Zinc and Its Alloys	Zinc	7440-66-6	0.001875	0.125	1250	0.045388	454
Sub-Total			1.5	100	1000000	36.310443	363104
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	0.09512	95.12	951200	2.302566	23026
Precious Metals	Gold	7440-57-5	0.00078	0.78	7800	0.018881	189
Precious Metals	Palladium	7440-05-3	0.0041	4.1	41000	0.099249	992
Sub-Total			0.1	100	1000000	2.420696	24207
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	1.77046	90.499972	905000	42.857458	428575
Other Plastics and Rubber	Carbon Black	1333-86-4	0.009782	0.500023	5000	0.236793	2368
Thermoplastics	Epoxy	85954-11-6	0.176068	9.000005	90000	4.262071	42621
Sub-Total			1.95631	100	1000000	47.356321	473563
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	0.472031	100	1000000	11.426436	114264
Sub-Total			0.472031	100	1000000	11.426436	114264
Total			4.131043			100	1000000

Important Note
The ppm calculations are at the **homogeneous material** level and are maximum concentration values. The ppm displayed represents the **homogeneous material** with the highest ppm for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.
The ppm calculations are at the **component** level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the **component**.
[See Glossary of Terms for more details.](#)

Important Part Information
There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology
[For an explanation of the methods used to determine material weights, See Product Content Methodology](#)

Material Declaration Certificate for Semiconductor IC Packaged Products
TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer
TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."
[For additional information, please contact TI customer support.](#)

[Signature: \(click here for a fuller statement with a signed certificate\)](#)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality
For further environmental statements, please go to www.ti.com/ecoinfo
Created on: 06/11/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in <http://www.ti.com/lit/pdf/szzq088>

Green: Means the content of Chlorine (Cl) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb2O3) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.